ID NUMBER	
PREPARATION	17-02-14

LDS1.5 SPECIFICATIONS

MODEL: HLS-LFCD2



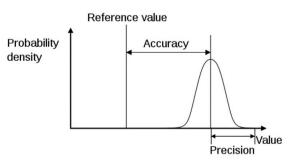
1. Basic Performance Specification

Items	Specifications
Operating supply voltage*	5VDC±5%
Light source	Semiconductor Laser Diode(λ=785nm)
Laser safety	IEC60825-1 Class 1
Current consumption	400mA or less (Rush current 1A)
Detection distance	120mm ~ 3,500mm
Interface	3.3V USART (230,400 bps) 42bytes per 6 degrees, Full Duplex option.
Ambient Light Resistance	10,000 lux or less
Sampling Rate	1.8kHz
Dimensions	69.5(W) X 95.5(D) X 39.5(H)mm
Mass	Under 125g

^{*} Target : white paper (Lambertian reflectance ≥ 80%)

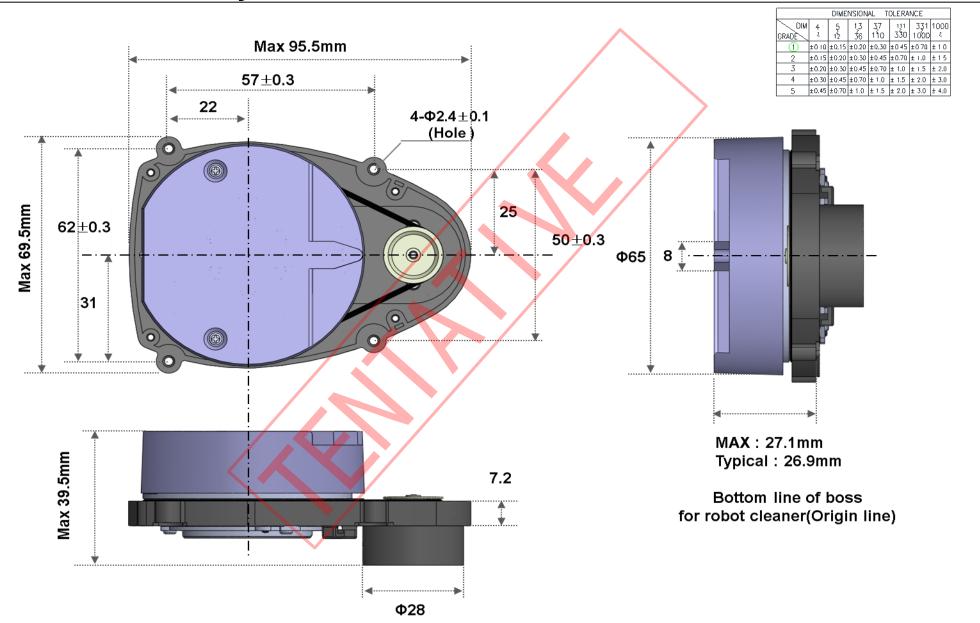
2. Standard Performance

Measurement performance		
Items	Spec.	Remarks
(1) Distance		White objects
Distance Range	120 ~ 3,500mm	- Lambertian Reflectance ≥80%
Distance Accuracy *		
120mm ~ 499mm	±15mm	
500mm ~ 3,500mm	±5.0%	
Distance Precision **		
120mm ~ 499mm	(±)10mm	X */
500mm ~ 3,500mm	(±) 3.5%	
(2) Rotation		
Scan Rate	300±10 rpm	
Angular Range	360°	
Angular Resolution	1°	

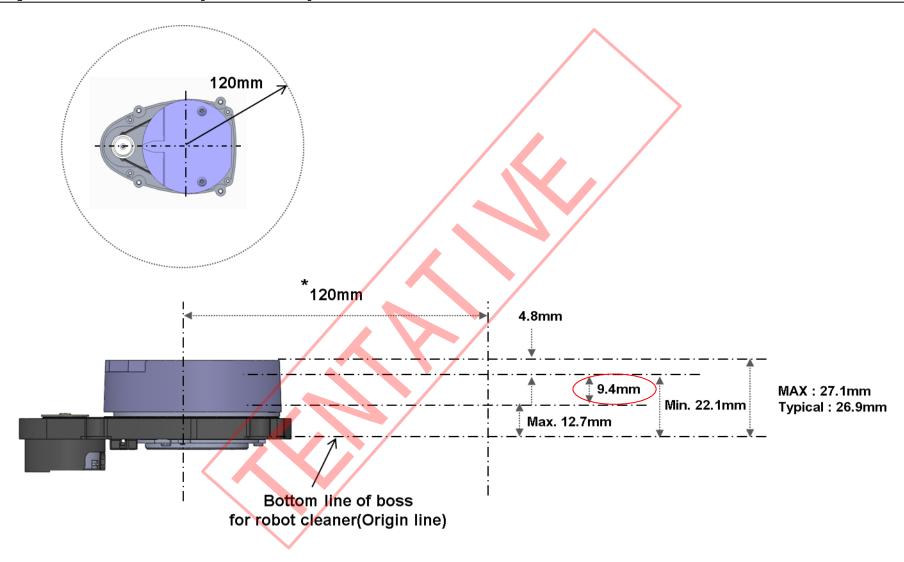


- $_{\star}$ Accuracy = Distance Average Reference Value
- ** $Precision = \frac{Max. Min.}{2}$

3. Mechanism Layout



4. Optical Path (9.4mm)



 $^{^{\}star}$ If the position is different, please contact HLDS about the exact dimension.

5. DATA INFORMATION

0	sync	FA	Fix	
0	Sylic	17	I IA	0xA0~0xDB
1	degree	A1	Angle Index	(0~60)
2	D DN4	C3	D.D.L.	low
3	RPM	0B	RPM	high
4	T	ВО		low
5	Intensity	22	1	high
6	D:-+ M	8B	Angle offset	low
7	Dist_M	00	0	high
8	Reserved*	00	1	low
9	- Keservea"	00	1	high
10	Into noite	2C		low
11	Intensity	30	1	high
12	Diet M	89	Angle offset	low
13	Dist_M	00	1	high
14	D	00	1	low
15	Reserved*	00	1	high
16	T	42		low
17	Intensity	27	1	high
18	D'-4 M	8A	Angle offset	low
19	Dist_M	00	2	high
20	Reserved*	00		low
21		00	1	high
22	T	3C		low
23	Intensity	21		high
24	Diet M	8C	Angle offset	low
25	Dist_M	00	3	high
26	Reserved*	00		low
27	Reserved"	00		high
28	Intonsitu.	C6		low
29	Intensity	0E		high
30	Dist M	98	Angle offset	low
31	DIST_IVI	00	4	high
32	Reserved*	00		low
33	neservea"	00		high
34	Intonsity	3F		low
35	Intensity	16] \ /	high
36	Dist_M	A4	Angle offset	low
37	DIST_IVI	00	5	high
38	Reserved*	00]	low
39	reserveu"	00	1	high
40	Checksum	13		low
41	Checksum	13	<u> </u>	high



- 1) angle = angle index*6 + angle offset
- 2) checksum information:

add all data 40bytes → checksum = 0xFF – checksum → save to 40, 41bytes (If calculated checksum is same with 40byte or 41byte, all data is valid.)

* This is reserved for compatibility

6. Pin Description & Command

• LDS 6-pin

	No.	Pin Name	Signal Description		
[6	Vcc(+5.0V)	Power supply for LDS core		
	5	TX	Serial output for host		
	4	PWM	LDS motor control PWM signal		
	3	GND	Ground		
	2	RX	Input signal for LDS operation		
	1	воото	Boot mode pin for update F/W (Used only HLDS)		

•	Moto	r 2-pin	
	No.	Pin Name	Signal Description
	2	Vcc(+5.0V)	Power supply for LDS Spindle motor
	1	PWM	LDS motor control PWM signal

^{*} Host circuit needs internal connections as above

Command

Key	Description
b	Begin operation (motor state & sensor)
е	Pause operation

7-1 RECOMMENDED CONNECTOR(LDS – 6Pin)

		-			
	Model No.		Dimensions(mm)		
Pin	TOP entry type	А	В	С	
6	11257W00-NP-S	6.25	10.75	6.70	
1.30	A 1.25 0.20 11 1	Circuit 1 03.2 0.30 4.05	Circuit 1	35 1.00	

7-2 RECOMMENDED CONNECTOR(Motor – 2Pin)

	Model No.		Dimensions(mm)			
Pin	TOP entry type	А	В	С	D	
2	SMW200-H02G	8.0	4.7	2.0	2.9	
2.0(PITC)	A C ±0.2	3.0	1.2	5.1	8.05	C±0.1 2.0±0.1 1.0±0.1 1.31.55 97 7 1949 P.C.B LAYOUT
A - A	<u> </u>	0.125	2	3.05 SEC A -	2.2 A"	